Silicon PNP Epitaxial

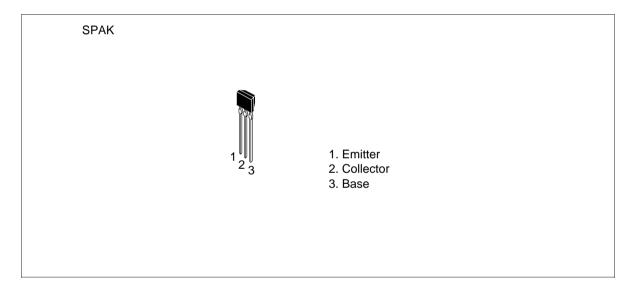


ADE-208-1014A (Z) 2nd. Edition Mar. 2001

Application

- Low frequency low noise amplifier
- HF amplifier

Outline



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	-55	V
Collector to emitter voltage	V _{CEO}	-50	V
Emitter to base voltage	V _{EBO}	-5	V
Collector current	I _c	-100	mA
Collector power dissipation	Pc	300	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C

Electrical Characteristics (Ta = 25°C)

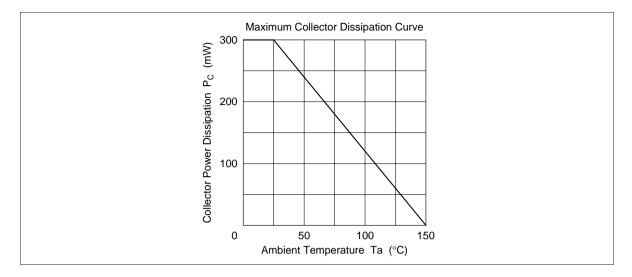
Item	Symbol	Min	Тур	Мах	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	-55	_	_	V	$I_{c} = -10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{\rm (BR)CEO}$	-50	_	—	V	$I_c = -1$ mA, $R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	-5	_	_	V	$I_{\rm E} = -10 \ \mu A, \ I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	_	_	-0.5	μΑ	$V_{CB} = -18 \text{ V}, I_{E} = 0$
Emitter cutoff current	I _{EBO}	_	—	-0.5	μΑ	$V_{EB} = -2 V, I_{C} = 0$
DC current transfer ratio	h_{FE}^{*1}	100	_	320		$V_{ce} = -12 \text{ V}, \text{ I}_{c} = -2 \text{ mA}$
Base to emitter voltage	V _{BE}	_	_	-0.75	V	$V_{ce} = -12 \text{ V}, \text{ I}_{c} = -2 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	—	—	-0.2	V	$I_{c} = -10 \text{ mA}, I_{B} = -1 \text{ mA}$
Gain bandwidth product	f _T	_	200		MHz	$V_{ce} = -12 \text{ V}, \text{ I}_{c} = -2 \text{ mA}$
Collector output capacitance	Cob	_	_	4.5	pF	$V_{CB} = -10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
Noise figure	NF	_	1.0	5.0	dB	$V_{ce} = -6 \text{ V}, \text{ I}_c = -0.1 \text{ mA},$ $R_g = 1 \text{ k}\Omega, \text{ f} = 1 \text{ kHz}$
Note: 1 The 2SA1337 is grouped by h ₌ as follows						

Note: 1. The 2SA1337 is grouped by h_{FE} as follows.

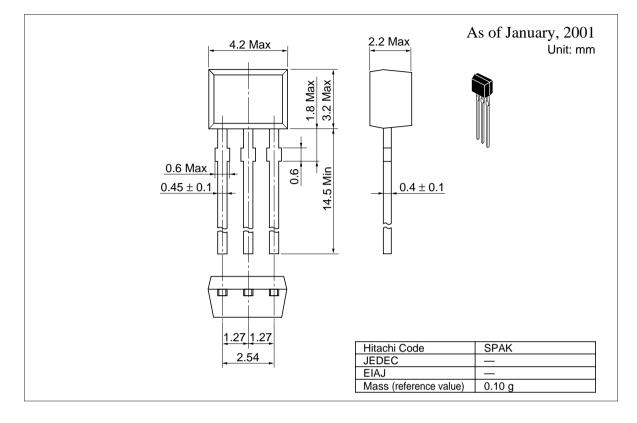
 B
 C

 100 to 200
 160 to 320

See characteristic curves of 2SA1052.



Package Dimensions



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